



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant : In-De OU et al. Confirmation No: 4280  
Appl. No. : 10/627,609  
Filed : July 28, 2003  
Title : CIRCUIT SUBSTRATE AND FABRICATION METHOD  
THEREOF

TC/A.U. : 2818  
Examiner : P. T. Dang

Docket No.: OUIN3001/REF  
Customer No: 23364

**AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

This is in response to the Official Action of January 31, 2005, in connection with the above-identified application. This response is timely filed.

Please amend the application as follows:

Amendments to the specification begin on page 2 of this paper.

Amendments to the drawings begin on page 3 of this paper.

Amendments to the claims are reflected in the listing of claims which begins on page 4 of this paper.

Remarks begin on page 8 of this paper.